

EN: This Datasheet is presented by the manufacturer.

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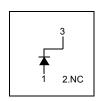
April 2008

BAS20

General Purpose High Voltage Diode







Connection Diagram

Absolute Maximum Ratings * T_A = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{RRM}	Maximum Repetitive Reverse Voltage	200	V
I _{F(AV)}	Average Rectified Forward Current	200	mA
I _{FSM}	Non-repetitive Peak Forward Surge Current Pulse Width = 1.0 second Pulse Width = 1.0 microsecond	1.0 2.0	A A
T _{STG}	Storage Temperature Range	-55 to +150	°C
T _J	Operating Junction Temperature	-55 to +150	°C

^{*} These ratings are limiting values above which the serviceability of the diode may be impaired.

Thermal Characteristics

Symbol	Parameter	Value	Units
P _D	Power Dissipation	350	mW
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W

$\textbf{Electrical Characteristics} \quad \textbf{T}_{A} = 25^{\circ}\text{C unless otherwise noted}$

Symbol	Parameter	Test Conditions	Min.	Max.	Units
V _R	Breakdown Voltage	I _R = 100μA	200		V
V _F	Forward Voltage	I _F = 100mA I _F = 200mA		1.0 1.25	V V
I _R	Reverse Leakage	V _R =50V V _R =50V, T _A = 150°C		100 100	nA μA
C _T	Total Capacitance	V _R = 0V, f = 1.0MHz		5	pF
t _{rr}	Reverse Recovery Time	$I_F = I_R = 30 \text{mA},$ $I_{RR} = 3.0 \text{mA}, R_L = 100 \Omega$		50	ns

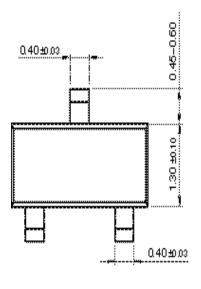
NOTES:

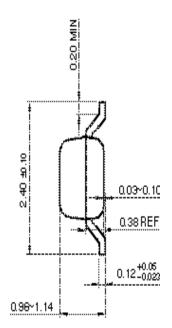
1) These ratings are based on a maximum junction temperature of 150 degrees C.

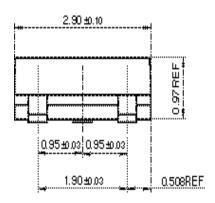
2) These are steady limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Mechanical Dimensions

SOT-23











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